

# IP4220CZ6 Dual USB 2.0 integrated ESD protection Rev. 5 – 8 July 2011

**Product data sheet** 

# 1. Product profile

#### 1.1 General description

The IP4220CZ6 is designed to protect I/O lines sensitive to capacitive load, such as USB 2.0, ethernet, Digital Video Interface (DVI) and so on, from damage due to ElectroStatic Discharge (ESD). It incorporates four pairs of ultra low capacitance rail-to-rail ESD protection diodes plus a Zener diode to provide protection to signal and supply components from ESD voltages up to  $\pm 8$  kV contact discharge. Protection is supply voltage independent due to the rail-to-rail diodes being connected to the Zener diode. The device is encapsulated in a small 6-lead SOT457 (SC-74) Surface-Mounted Device (SMD) plastic package.

### **1.2 Features and benefits**

- Pb-free, Restriction of Hazardous Substances (RoHS) compliant and free of halogen and antimony (Dark Green compliant)
- ESD protection up to ±8 kV contact discharge; IEC 61000-4-2, level 4 compliant
- Four pairs of ultra low input capacitance (C<sub>I</sub> = 1 pF) ESD rail-to-rail protection diodes
- Low voltage clamping due to integrated Zener diode
- Small 6-lead TSOP6 (SOT457) SMD package

#### **1.3 Applications**

- General-purpose downstream ESD protection for high-frequency analog signal ports and high-speed serial data transmission ports in:
  - Cellular phone and Personal Communication System (PCS) mobile handsets
  - PC/notebook USB 2.0/IEEE1394 ports
  - DVI
  - Cordless telephones
  - Wireless data (WAN/LAN) systems
  - Mobile Internet Devices (MID)
  - Portable media Players (PMP)
  - High-Definition Multimedia Interface (HDMI)



018aaa142

#### **Dual USB 2.0 integrated ESD protection**

# 2. Pinning information

Table 1.	Pinning			
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	I/O 1	ESD protection		
2	GND	ground		6 5 4
3	I/O 2	ESD protection	0	
4	I/O 3	ESD protection		
5	VP	supply voltage		
6	I/O 4	ESD protection		
				1 2 3

# 3. Ordering information

Table 2.         Ordering information						
Type number	Package					
	Name	Description	Version			
IP4220CZ6	SC-74	plastic surface-mounted package (TSOP6); 6 leads	SOT457			

# 4. Marking

Table 3.   Marking codes	
Type number	Marking code
IP4220CZ6	20

# 5. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Мах	Unit
VI	input voltage		0	5.5	V
$V_{ESD}$	electrostatic discharge voltage	IEC 61000-4-2, level 4, contact; all pins	-8	+8	kV
T <sub>stg</sub>	storage temperature		-55	+125	°C

# 6. Recommended operating conditions

Table 5.	Operating conditions					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub>	ambient temperature		-40	-	+85	°C

**Dual USB 2.0 integrated ESD protection** 

## 7. Characteristics

Table 6.Characteristics $T_{amb} = 25 \ ^{\circ}C$ ; unless otherwise specified.						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
C <sub>(I/O-GND)</sub>	input/output to ground capacitance	V <sub>I</sub> = 0 V; f = 1 MHz; V <sub>P</sub> = 3 V	<u>[1]</u> -	1.0	-	pF
$C_{(zd-GND)}$	Zener diode to ground capacitance	V <sub>I</sub> = 0 V; f = 1 MHz; V <sub>P</sub> = 3 V	<u>[3]</u> _	40	-	pF
I <sub>RM</sub>	reverse leakage current	$V_I = 3 V$	[2] _	-	100	nA
$V_{BRzd}$	Zener diode breakdown voltage	l = 1 mA	<u>[3]</u> 6	-	9	V
V <sub>F</sub>	forward voltage		-	0.7	-	V

[1] Pins 1, 3, 4 and 6.

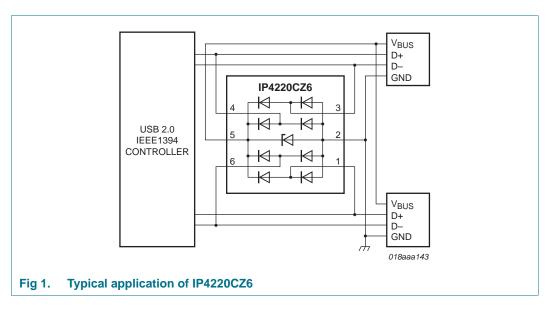
[2] Pins 1, 3, 4 and 6 to ground.

[3] Pin 5 to pin 2.

# 8. Application information

#### 8.1 Universal serial bus 2.0 protection

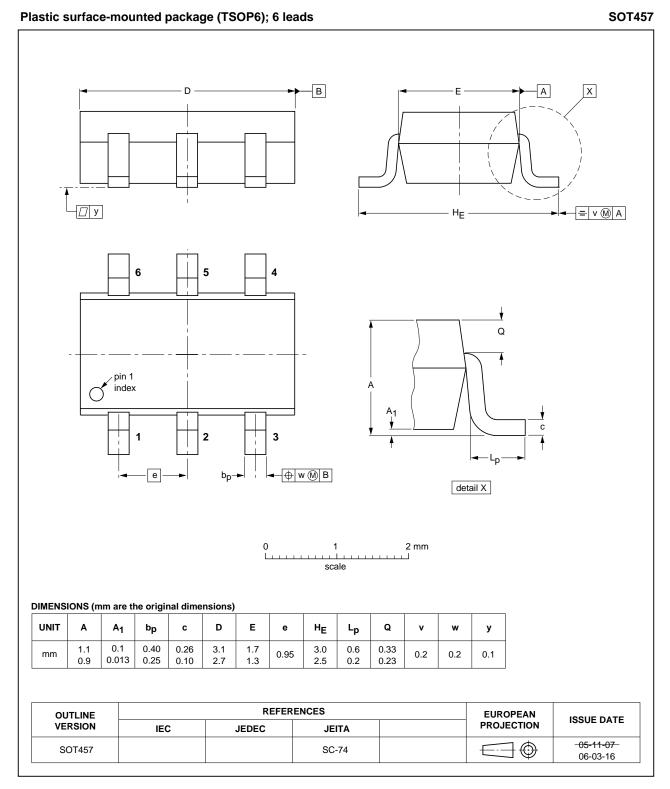
The device is optimized to protect, for example, two USB 2.0 ports from ESD. Each device can protect both USB data lines and the  $V_{BUS}$  supply line. A typical application is shown in Figure 1.



Product data sheet

**Dual USB 2.0 integrated ESD protection** 

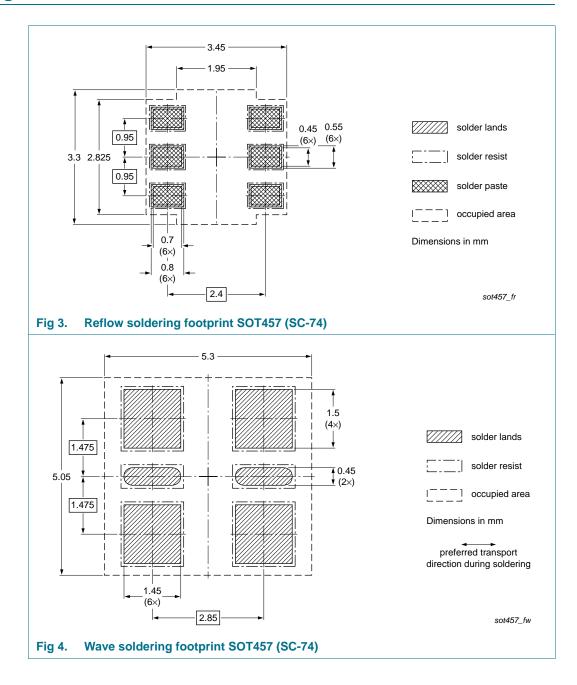
## 9. Package outline



#### Fig 2. Package outline SOT457 (SC-74)

#### **Dual USB 2.0 integrated ESD protection**

# **10. Soldering**



#### Dual USB 2.0 integrated ESD protection

# 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
IP4220CZ6 v.5	20110708	Product data sheet	-	IP4220CZ6 v.4			
Modifications:		of this document has been r f NXP Semiconductors.	edesigned to comply v	vith the new identity			
	<ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>						
	<ul> <li>Section 1 "Product profile": updated</li> </ul>						
	<ul> <li>Section 2 "Pinning information": updated</li> </ul>						
	<u>Section 4 "Marking"</u> : added						
	<ul> <li><u>Table 4</u> and <u>6</u>: parameters V<sub>I/O</sub>; V<sub>esd</sub>; C<sub>I/O(n)</sub>; V<sub>I/O(n)</sub>; I<sub>L(n)</sub>; C<sub>d(Zener)</sub> and V<sub>BR(Zener)</sub> redefined respectively to V<sub>I</sub>; V<sub>ESD</sub>; C<sub>(I/O-GND)</sub>; V<sub>I</sub>; I<sub>RM</sub>; C<sub>(zd-GND)</sub> and V<sub>BRzd</sub>.</li> </ul>						
	• Figure 1: updated						
	<ul> <li>Figure 2 "Package outline SOT457 (SC-74)": updated</li> </ul>						
	<ul> <li>Section 8.2. IP4220CZ6 spice model: deleted</li> </ul>						
	<ul> <li><u>Section 10 "Soldering"</u>: added</li> </ul>						
	Abbreviation table: deleted						
	Section 12 "	Legal information": updated					
P4220CZ6 v.4	20050912	Product data sheet	-	IP4220CZ6 v.3			
P4220CZ6 v.3	20050712	Product data sheet	-	IP4220CZ6 v.2			
P4220CZ6 v.2	20050608	Product data sheet	-	IP4220CZ6_N v.1			
P4220CZ6 N v.1	20040917	Preliminary specification	- n	-			

6 of 9

#### **Dual USB 2.0 integrated ESD protection**

# 12. Legal information

#### 12.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

#### 12.2 Definitions

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

**Product specification** — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

#### 12.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or

malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nxp.com/profile/terms">http://www.nxp.com/profile/terms</a>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

#### **Dual USB 2.0 integrated ESD protection**

**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

**Non-automotive qualified products** — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the

# 13. Contact information

product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

#### 12.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

#### **Dual USB 2.0 integrated ESD protection**

## 14. Contents

1	Product profile
1.1	General description 1
1.2	Features and benefits 1
1.3	Applications 1
2	Pinning information 2
3	Ordering information 2
4	Marking 2
5	Limiting values 2
6	Recommended operating conditions 2
7	Characteristics 3
8	Application information
8.1	Universal serial bus 2.0 protection 3
9	Package outline 4
10	Soldering 5
11	Revision history 6
12	Legal information 7
12.1	Data sheet status 7
12.2	Definitions
12.3	Disclaimers
12.4	Trademarks8
13	Contact information 8
14	Contents 9

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2011.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 8 July 2011 Document identifier: IP4220CZ6